



AO3401

P-Channel Enhancement Mode Field Effect Transistor

General Description

The AO3401 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications. Standard product AO3401 is Pb-free (meets ROHS & Sony 259 specifications).

Features

 $V_{DS}(V) = -30V$

 $I_D = -4.2 \text{ A } (V_{GS} = -10 \text{V})$

 $R_{DS(ON)}\!<50m\Omega$ (V $_{GS}$ = -10V)

 $R_{DS(ON)}$ < 65m Ω (V_{GS} = -4.5V)

 $R_{DS(ON)}$ < 120m Ω (V_{GS} = -2.5V)





Absolute Maximum Ratings T _A =25°C unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	-30	V				
Gate-Source Voltage		V_{GS}	±12	V				
Continuous Drain	T _A =25°C		-4.2					
Current ^A	T _A =70°C	I_D	-3.5	Α				
Pulsed Drain Current ^B		I_{DM}	-30					
	T _A =25°C	P_{D}	1.4	W				
Power Dissipation A	T _A =70°C		1	VV				
Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150	°C				

Thermal Characteristics								
Parameter		Symbol	Symbol Typ Ma		Units			
Maximum Junction-to-Ambient A	t ≤ 10s	$-$ R _{θJA}	65	90	°C/W			
Maximum Junction-to-Ambient A	Steady-State	N _θ JA	85	125	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	43	60	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC F	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =-250μA, V _{GS} =0V		-30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-24V, V _{GS} =0V				-1	
			T _J =55°C			-5	μΑ
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±12V				±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=-250\mu A$		-0.7	-1	-1.3	V
$I_{D(ON)}$	On state drain current	V _{GS} =-4.5V, V _{DS} =-5V		-25			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-10V, I _D =-4.2A			42	50	mΩ
			T _J =125°C			75	1112.2
		V _{GS} =-4.5V, I _D =-4A			53	65	mΩ
		V_{GS} =-2.5V, I_D =-1A		80	120	mΩ	
g _{FS}	Forward Transconductance	V _{DS} =-5V, I _D =-5A		7	11		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V			-0.75	-1	V
Is	Maximum Body-Diode Continuous Current					-2.2	Α
I _{SM}	Pulsed Body-Diode Current					-30	Α
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-15V, f=1MHz			954		pF
C _{oss}	Output Capacitance				115		pF
C _{rss}	Reverse Transfer Capacitance				77		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			6		Ω
SWITCHI	NG PARAMETERS						
Q_g	Total Gate Charge	V _{GS} =-4.5V, V _{DS} =-15V, I _D =-4A			9.4		nC
Q_{gs}	Gate Source Charge				2		nC
Q_{gd}	Gate Drain Charge				3		nC
t _{D(on)}	Turn-On DelayTime				6.3		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =3.6 Ω , R_{GEN} =6 Ω			3.2		ns
t _{D(off)}	Turn-Off DelayTime				38.2		ns
t _f	Turn-Off Fall Time				12		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-4A, dI/dt=100A/μs			20.2		ns
Q _{rr}	Body Diode Reverse Recovery Charge I _F =-4A, dl/dt=100A/μs				11.2		nC

A: The value of R_{BJA} is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any a given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating. B: Repetitive rating, pulse width limited by junction temperature.

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C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using <300 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

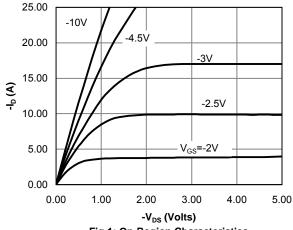


Fig 1: On-Region Characteristics

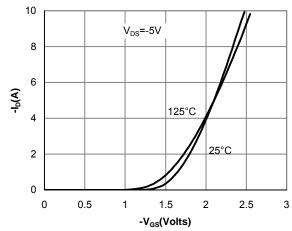


Figure 2: Transfer Characteristics

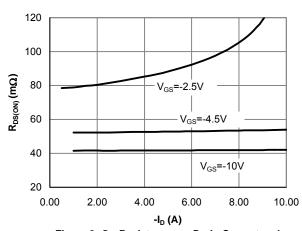


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

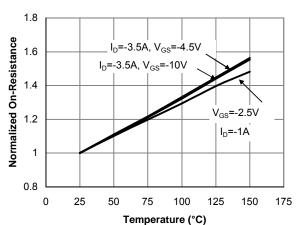


Figure 4: On-Resistance vs. Junction Temperature

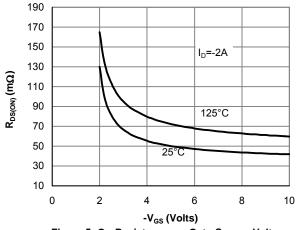


Figure 5: On-Resistance vs. Gate-Source Voltage

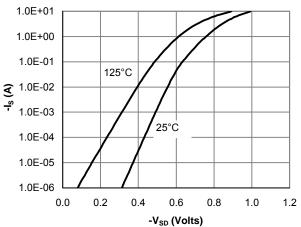


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

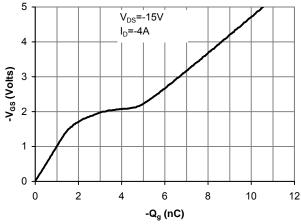


Figure 7: Gate-Charge Characteristics

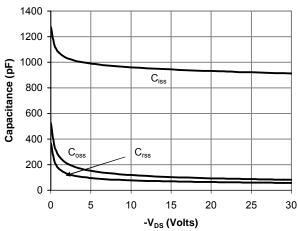


Figure 8: Capacitance Characteristics

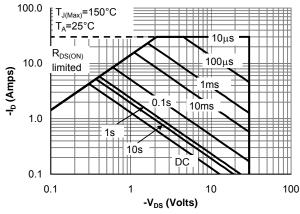


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

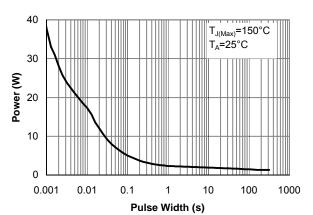


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

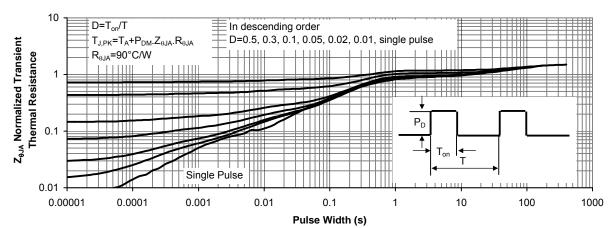


Figure 11: Normalized Maximum Transient Thermal Impedance